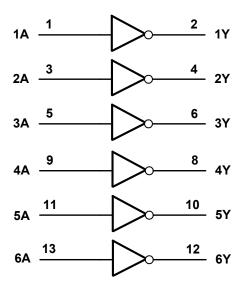


Pin Descriptions

Pin Number	Pin Name	Function
1	1A	Data Input
2	1Y	Data Output
3	2A	Data Input
4	2Y	Data Output
5	3A	Data Input
6	3Y	Data Output
7	GND	Ground
8	4Y	Data Output
9	4A	Data Input
10	5Y	Data Output
11	5A	Data Input
12	6Y	Data Output
13	6A	Data Input
14	V _{CC}	Supply Voltage

Logic Diagram



Function Table

Input	Output
Α	Υ
Н	L
L	Н



Absolute Maximum Ratings (Note 4) (@T_A = +25°C, unless otherwise specified.)

Symbol	Description	Rating	Unit
ESD HBM	Human Body Model ESD Protection	2	KV
ESD CDM	Charged Device Model ESD Protection	1	KV
ESD MM	Machine Model ESD Protection	200	V
V _{CC}	Supply Voltage Range	-0.5 to +7.0	V
VI	Input Voltage Range (Note 5)	-0.5 to +7.0	V
I _{IK}	Input Clamp Current V _I < -0.5V or Vi > V _{CC} +0.5V	±20	mA
lok	Output Clamp Current $V_O < -0.5V$ or $V_O > V_{CC} +0.5V$	±20	mA
Io	Continuous output current $-0.5V < V_O V_{CC} +0.5V$	+/- 25	mA
Icc	Continuous current through V _{CC}	50	mA
I _{GND}	Continuous current through GND	-50	mA
TJ	Operating Junction Temperature	-40 to +150	°C
T _{STG}	Storage Temperature	-65 to +150	°C
P _{TOT}	Total Power Dissipation	500	mW

Notes:

Recommended Operating Conditions (Note 6) (@T_A = +25°C, unless otherwise specified.)

Symbol	Parameter	Conditions	Min	Max	Unit
V_{CC}	Supply Voltage		2.0	6.0	V
V_{I}	Input Voltage		0	Vcc	V
Vo	Output Voltage		0	V _{CC}	V
		$V_{CC} = 2.0V$		625	
Δt/ΔV	Input Transition Rise or Fall Rate	$V_{CC} = 4.5V$		140	ns/V
		$V_{CC} = 6.0V$		85	
T_A	Operating free-air temperature		-40	+125	°C

Note: 6. Unused inputs should be held at V_{CC} or Ground.

^{4.} Stresses beyond the absolute maximum may result in immediate failure or reduced reliability. These are stress values and device operation should be within recommend values.

^{5.} Input Voltage cannot exceed V_{CC} to the extent the Maximum clamp current is exceeded.



Electrical Characteristics (@T_A = +25°C, unless otherwise specified.)

Cumb al	Down was a to w	Took Conditions	.,,	T _A = -40°	C to +85°C	T _A = -40°C	to +125°C	l lait
Symbol	Parameter	r Test Conditions	V _{CC}	Min	Max	Min	Max	Unit
			2.0V	1.5		1.5		
V_{IH}	High-level Input Voltage		4.5V	3.15		3.15		V
	Voltage		6.0V	4.2		4.2		
	1 1 1 4		2.0V		0.5		0.5	
V_{IL}	Low-level input voltage		4.5V		1.35		1.35	V
	Voltage		6.0V		1.8		1.8	
	High-level Output Voltage	I _{OH} = -20μA	2.0V	1.9		1.9		V
		I _{OH} = -20μA	4.5V	4.4		4.4		
V _{OH}		I _{OH} = -20μA	6.0V	5.9		5.9		
		I _{OH} = -4.0mA	4.5V	3.84		3.7		
		I _{OH} = -5.2mA	6.0V	5.34		5.2		
		I _{OL} = 20μA	2.0V		0.1		0.1	
		I _{OL} = 20μA	4.5V		0.1		0.1	
V_{OL}	Low level Output Voltage	I _{OL} = 20μA	6.0V		0.1		0.1	V
	Voltage	I _{OL} = 4mA	4.5V		0.33		0.44	
		I _{OL} = 5.2mA	6.0V		0.33		0.44	
II	Input Current	V _I =GND to 5.5V	6.0V		± 1		± 1	μA
Icc	Supply Current	$V_I = GND \text{ or } V_{CC}, I_O = 0$	6.0V		20		40	μA

Switching Characteristics

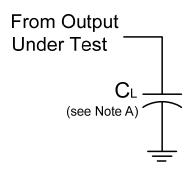
Symbol	Symbol Parameter Test Conditions				Γ _A = +25°C	;	-40°C to +85°C	-40°C to +125°C	Unit	
Symbol			V CC	Min	Тур	Max	Max	Max	Oiiit	
	Dropogation	Figure 1	2.0V		25	90	115	135		
t _{PD}	Delay A _N to Y _N	Propagation Figure 1 Delay A _N to Y _N C ₁ =50 pF			9	18	23	27	ns	
	Delay AN to TN	OL-30 pi	6.0V		7	15	20	23		
		C: 1	2.0V		19	75	95	110		
t _t	Transition time	Transition time Figure 1	C _i =50 pF	4.5V	_	7	15	19	22	ns
		OL−30 pi	6.0V	_	6	13	16	19		

Operating Characteristics (@T_A = +25°C, unless otherwise specified.)

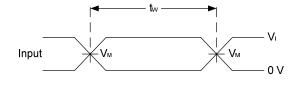
Parameter		Test Conditions	V _{CC} = 6V	Unit
	T drameter	Test conditions	Тур	Oilit
C _{pd}	Power Dissipation Capacitance per Gate	f = 1 MHz	22	pF
Cı	Input Capacitance	$V_I = V_{CC} - \text{or GND}$	4	pF



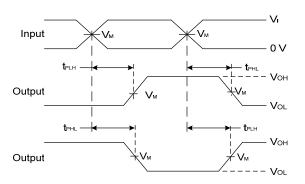
Parameter Measurement Information



V	Inp	outs	.,	C.	
V _{CC}	VI	t _r /t _f	VM	C _L	
2.0V to 6.0V	V _{CC}	6ns	V _{CC} /2	15pF,50pF	



Voltage Waveform Pulse Duration



Voltage Waveform Propagation Delay Times **Inverting and Non Inverting Outputs**

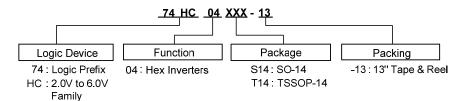
Notes:

- A. Includes test lead and test apparatus capacitance. B. All pulses are supplied at pulse repetition rate \leq 1 MHz.
- C. Inputs are measured separately one transition per measurement.
- D. t_{PLH} and t_{PHL} are the same as $t_{PD.}$

Figure 1 Load Circuit and Voltage Waveforms



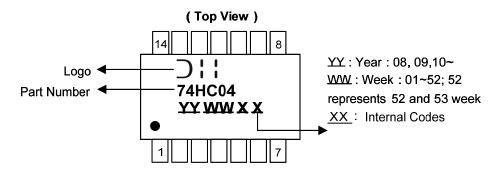
Ordering Information



	Device	Dookses Code	Dookoaina	7" Tape a	and Reel
	Device	Package Code	Packaging	Quantity	Part Number Suffix
Pb.	74HC04S14-13	S14	SO-14	2500/Tape & Reel	-13
Pb.	74HC04T14-13	T14	TSSOP-14	2500/Tape & Reel	-13

Marking Information

(1) SO-14, TSSOP-14



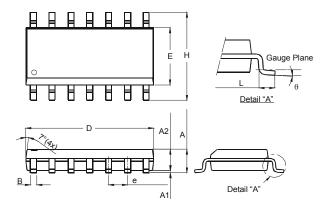
Part Number	Package
74HC04S14	SO-14
74HC04T14	TSSOP-14



Package Outline Dimensions (All dimensions in mm.)

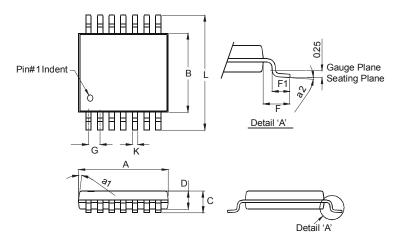
Please see AP02002 at http://www.diodes.com/datasheets/ap02002.pdf for latest version.

Package Type: SO-14



	SO-14					
Dim	Min	Max				
Α	1.47	1.73				
A1	0.10	0.25				
A2	1.45	Тур				
В	0.33	0.51				
D	8.53	8.74				
Е	3.80	3.99				
е	1.27	Тур				
Н	5.80	6.20				
L	0.38	1.27				
θ	0°	8°				
All Di	All Dimensions in mm					

Package Type: TSSOP-14

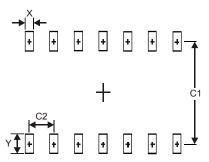


	TSSOP-14						
Dim	Min	Max					
a1	7° (4X)					
a2	0°	8°					
Α	4.9	5.10					
В	4.30	4.50					
С		1.2					
D	0.8	1.05					
F	1.00	Тур					
F1	0.45	0.75					
G	0.65	Тур					
K	0.19 0.30						
L 6.40 Typ							
All Dir	nensions	s in mm					

Suggested Pad Layout

Please see AP02001 at http://www.diodes.com/datasheets/ap02001.pdf for latest version.

Package Type: SO-14

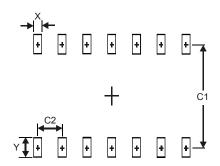


Dimensions	Value (in mm)
Х	0.60
Y	1.50
C1	5.4
C2	1.27



Suggested Pad Layout (cont.)

Package Type: TSSOP-14



Dimensions	Value (in mm)
Х	0.45
Y	1.45
C1	5.9
C2	0.65

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